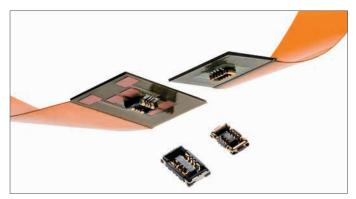
MICROMINIATURE CONNECTORS > DESIGN GUIDE





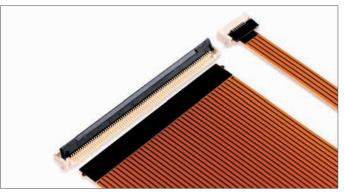
MOLEX MICRO CONNECTORS FAMILY LINEUP



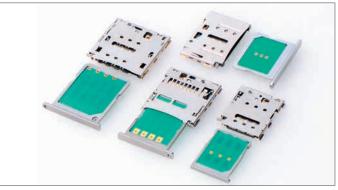
Micro Board-to-Board



Micro Wire-to-Board & Wire-to-Wire



Micro FFC/FPC



Micro Memory Card

GLOBAL DESIGN AND MANUFACTURING CAPABILITIES



Molex has product design and production facilities in each region of the world in order to meet local customer needs. Our global capabilities enable us to provide the latest micro connector design and manufacturing solutions to quickly meet your requirements.

INTRODUCTION

Molex is a pioneer in the development of microminiature connectors. Our micro connectors are finding use today in applications ranging from mobile devices to automotive, medical and more. We are continuing to develop lower profiles, narrower pitch ranges, and higher speed capabilities to meet ever-evolving downsizing and functional needs. Our micro connectors are packed with innovative features to offer secure mating reliability, ease-of-use and design flexibility. Backed by a global network of engineering and manufacturing capabilities, Molex offers local service and a global array of design services for all your microminiature connector needs.

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> Micro Board-to-Board

SlimStack™	0.35, 0.40, 0.50mm Pitch	10-11
SlimStack™	0.635, 0.80, 1.00mm Pitch	12-13

Micro Wire-to-Board and Wire-to-Wire Connectors

24-25 2.00, 3.00, 4.20mm Pitch 0.40 - 1.25mm Pitch 18-19 Specialty Connectors for Automotive and Micro IDT Coaxial Lighting Applications Pico-Lock™ DuraClik[™] Standard, ISL and TPA Pico-Clasp[™] Lite-Trap[™], Mini Lite-Trap[™] Pico-EZmate[™] TermiMate™ CLIK-Mate[™] Duo-Clasp[™] PicoBlade™ 1.00, 1.25, 2.00, 2.50, 3.50, 3.70mm Pitch 26-27 Specialty Connectors for LED Applications 1.50mm Pitch 20-21 IllumiMate™ PanelMate™ Pico-Lock™ Flexi-Mate[™] Pico-SPOX[™] Wire-to-Wire Connectors CLIK-Mate™ PicoBlade™ MicroTPA™ 22-23 2.00mm Pitch CLIK-Mate™ iGrid™ MicroClasp™ MicroBlade™ Micro-Latch™ Micro-Lock[™] MicroTPA™

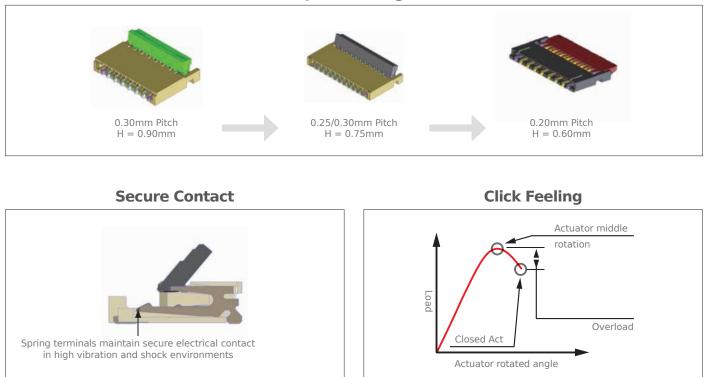
Board-In

Micro Memory Card Connectors

nano-SIM, micro-SIM and Combos	14-15
microSD	16-17

0.20/0.25/0.30mm Pitch Innovations

Space Savings



FPC Locking



Locking features on both sides provide secure cable retention

Actuator Stability



Actuator features enable it to remain open for more efficient assembly

> Micro FFC/FPC Connectors (0.20, 0.25 and 0.30mm Pitch)

Pitch (mm)	Image	Mated Height	Width	Series Number	Circuit Sizes	Mounting	Actuator Type	Contact Type	Contact Plating	Current (max.)	Voltage (max.)	FPC Thickness (mm)
		0.60	3.30	505094	12		Easy-On™ BackFlip™	Dual				0.12
0.20		0.90	2.85	503419	67, 71, 81		Easy-On™ Front Flip	Bottom				
		0.95	3.00	504070	39, 51, 61		Easy-On™ BackFlip™	Dual		0.2A		
		1.00	2.98	502078	13, 17, 21, 25, 33, 37, 39, 51, 53, 61	Right	Easy-On™ Front Flip Easy-On™ BackFlip™	Bottom				
0.25		1.20	2.65	503300	21, 29, 31, 37, 41, 43, 53			Тор				
		1.65	2.98	503320	25, 37, 41			Bottom		0.24	- 50V	0.20
		0.75	3.30	504754	7, 15, 31, 39, 51					0.3A		
		0.90	3.53	502250	15, 17, 21, 23, 27, 33, 35, 39, 41, 51	Angle		Dual	Gold	0.2A		
	Section of the sectio	0.05	2.85	503566	9, 11, 13, 15, 17, 19, 21, 23, 25, 27, 31, 33, 35, 37, 39, 41, 43, 45, 51		Easy-On™ Front Flip	Bottom	0	U.ZA		
		0.95	3.80	504740	19, 23, 25, 33, 39, 41, 45, 51, 61		Easy-On™ BackFlip™		-	0.24		
0.30		1.00	2.55	504281	11, 13, 17, 19		Non-ZIF			0.3A		0.30
		1.15	3.80	502598	15, 17, 23, 25, 27, 29, 33, 39, 45, 51		Easy-On™	Dual				
		1.20	4.00	503425	61, 75		BackFlip™			0.2A		0.20
		1.80	3.85	501912	15, 21, 23, 25, 27, 33, 35, 37, 39, 41, 45, 47, 51		Easy-On™ Front Flip	Bottom				

*Note: All dimensions in mm

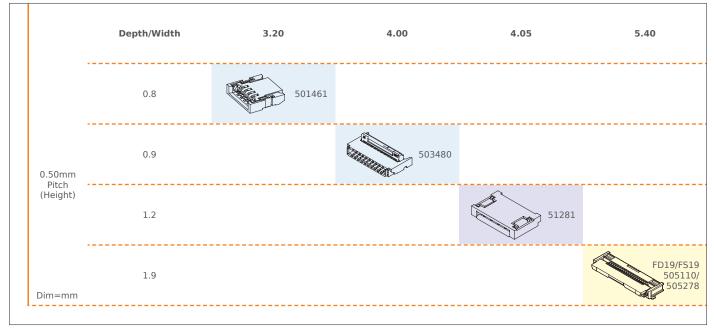
0.50/1.00mm Pitch Innovations





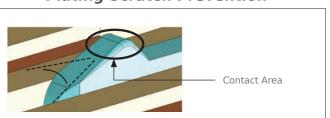
• 24% size reduction for PCB and height space savings

Various Design Options



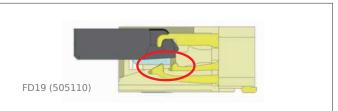
Wide SelectionImage: Distribution of the selection<

Actuator Types: BackFlip[™], Front Flip, Non-ZIF, Slider, Flip



Angled and rounded design guides FPC and prevents scratching from cable leads

Double Bottom Contacts



Double bottom contacts remove dust and debris for improved contact reliability

Plating Scratch Prevention

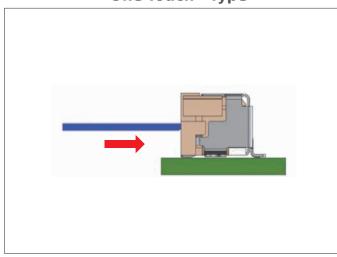
> Micro FFC/FPC Connectors (0.50 and 1.00mm Pitch)

Pitch (mm)	Mated Height	Image	Width	Series Number	Circuit Sizes	Mounting	Actuator Type	Contact Type	Contact Plating	Current (max.)	Voltage (max.)	FPC Thickness (mm)
	0.80		3.20	501461	4, 5, 6, 8		Easy-On™	Bottom		0.3A		0.12
	1.00		4.00	503480	4, 6, 8, 10, 12, 14, 16, 17, 18, 20, 22, 26, 32	-	BackFlip™	Dual				
			4.05	51281	5 to 12, 14, 16, 18, 20, 22, 24, 26		Non-ZIF	Dual				
	1.20		3.85	54548	4 to 20, 22, 24, 26		Slider	Bottom				
		Single and the second s	5.05	54550	54550 4 to 14, 16 to 22, 24, 26 Top							
	1.30		4.30	51296	8, 12, 14, 18, 34, 40, 45, 50, 54, 60			Bottom				
	1.90		5.30	505110 (FD19)	4 to 80	Right Angle	Easy-On™ Front Flip	Double Bottom				
0.50	1.90		5.50	505278 (FS19)	4 to 28			Bottom	Gold	0.5A	50V	
			5.20 52437 21 to 30 Bo	Bottom								
			5.00	52745	4, 6 to 20		Slider	Тор	_			0.30
	2.00		5.00	52746	4, 6 to 20			Bottom				
			5.60	54104	30, 32, 33, 34, 35, 36, 38, 40, 45, 46, 50			Тор				
			5.60	54132	30, 32, 33, 34, 35, 36, 38, 40, 43, 45, 50	-		Bottom				
	3.90		3.40	52559	6, 9, 10, 12, 14, 15, 16, 20, 21, 24, 26, 27, 28, 30, 32, 36, 40	Vertical		N/A				
	4.05	A DE	4.50	501951	20, 22, 24, 30, 32, 40, 45, 59, 60, 70	Vertical	Flip Type	N/A		0.4A		
	2.70	A CONTRACTOR	5.60	52207	3 to 30, 34		Clider	Тор		1.0A	1251/	
	3.00		5.40	52271	4 to 30	Right	Slider	Dattana		0.5A	125V	
1.00	2.10		6.00	52852	4 to 20, 22 to 30	Angle		Bottom	Tir Discouth	1.0A	501/	
1.00	00 3.10 -	Contraction of the second seco	6.80	52793	3 to 30		Non-ZIF	Тор	Tin-Bismuth	0.54	50V	
	5.10	Contraction of the second	4.50	52808	4 to 30	Mentio		N/A		0.5A	10514	
	5.75	and the second sec	4.50	52610	5 to 26, 28, 30	Vertical	Slider	N/A		1.0A	125V	

*Note: All dimensions in mm

0.50 - 1.00mm Pitch Innovations

"One-Touch" Type



 One-touch cable insertion eliminates need for actuator and provides strong cable retention (503908)

Standard Type

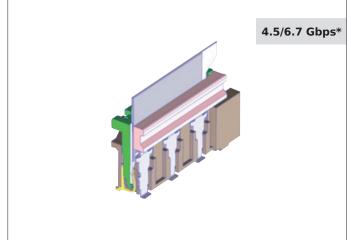


- Side-push-lock release buttons provide space savings, no downward stress on PCB and avoid lock release due to external force on chassis compared to top-button designs (503908)
- FPC shielding
 5.3 Gbps*

 Grounding terminals
 Straight and right-angle versions (502244/502231)

*Note: Contact Molex for specific speed simulation data



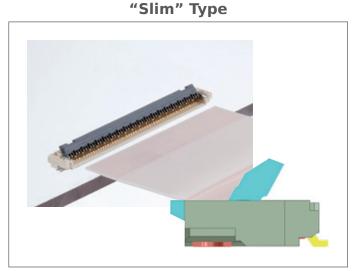


• Jacket and cover design provide secure electrical contact and cable hold (501783/501784/501786/501864)



 Provides high voltage-carrying capabilities, and lower applied costs than wire-to-board types (49456)

High Voltage Type



• "Slim" type offers compact size and high circuit sizes (104114)

Micro FFC/FPC Connectors

0.50/1.00mm Pitch

Pitch (mm)	Mated Height	Width	Series Number	Image	Circuit Sizes	Mounting	Actuator Type	Contact Type	Contact Plating	Current (max.)	Voltage (max.)	FPC Thickness (mm)
	1.50	4.40	104114		80			Bottom				
	1.50	5.30	104234	4184 50, 68 Easy-On™ Bottom Gold								
0.50	2.00	5.00	104184			Bottom	Gold	0.5A	50V	0.30		
	2.50	5.30	104060		20, 60, 80	Right Angle		Double				0.50
	2.30	5.50	502790		30, 40, 50, 60, 64, 80			Bottom				
1.00	2.80	6.70	49456	A STATE OF STATE	12		Easy-On™ BackFlip™	Bottom	Tin	1.0A	125V	

> LVDS FFC Connectors: One-Piece Type

Pitch (mm)	Mounting	Series Number	Circuit Sizes	Actuator Type	Contact Type	Speed*	Plating	Current (max.)	Voltage (max.)	FPC Thickness (mm)
	Right Angle	H=3.75, W=5.85 503908	41, 51	Non-ZIF "One-Touch" With Side Buttons	Bottom	40 Gbps		0.5A	- 50V	0.33 (Contact area)
0.50	Right Angle	H=6.50, W=5.45 502244	15 04 00	Easy-On™ Front Flip	Dottom	Contact	Gold	0.4A		0.30 (Contact area); 0.50 (Ground area)
	Vertical	H=2.33, W=5.60 502231	15, 24, 33	Easy-On™	N/A	Molex		0.4A		0.30 (Contact area); 0.50 (Ground area)

*Note: Contact Molex for specific speed simulation data

> LVDS FFC Connectors: Two-Piece Type

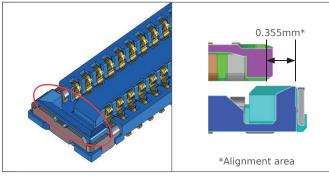
Pitch (mm)	Plug Jacket	Plug Jacket Cover	PCB Receptacle, Vertical	PCB Receptacle, Right Angle	Circuit Sizes	Speed [†]	Current (max.)	Voltage (max.)	Contact Plating	FPC Thickness (mm)
0.50	501783	501784	H=8.95, W=4.55 501786 Grounding Type	H=4.85, W=9.50 501864 Grounding Type	30, 50, 80	501786 (20 Gbps) 501864 (10 Gbps)	0.3A	50V	Signal (Gold) Ground (Tin)	0.30 (Contact area); 0.44 (Shield area)

***Note 1**: Height and width equals mated dimensions in mm. '**Note 2**: The speed is derived from the simulation result on GSSGSSG differential 100Ω signaling for only the connector portion (does not contain any PCB/FPC characteristics). The speed (Gbps) is obtained by simply doubling the usable frequency (GHz), which is defined as the frequency at which the insertion loss exceeds -3dB. Return loss and crosstalk are not taken into account when determining the speed values here. However, they should be considered when judging the connector's overall capabilities.

> Micro Board-to-Board Connectors

SlimStack[™] Family Innovations

Wide Alignment Guide



- Easy to mate and find right position
- Good for assembly operator
- More efficient assembly
- (504618/504622)

• 3A power (left)

.

• 6A power (right)

Left: (505066/505070)

• Right: Hybrid Power (505004/505006)

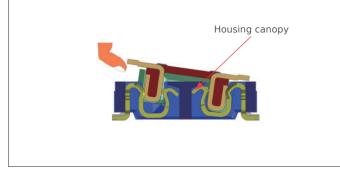
Robust Protection

- Armored metal covers prevent housing damage during mating
- SlimStack Armor[™] series
- (505066/505070)
- Power Supply

Electrical Reliability

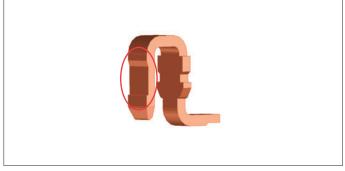
- Dual contact design for secure electrical and mechanical contact (SSB6, left)
- Triple-lock for high-retention force (503548/503552, right)





Housing canopy provides anti-zippering barrier that prevents contact pull-out from angled mating

"Click Feeling"



 Contact lock with drop-off gap creates good tactile "click" feeling for mating assurance (503304/503308)

• (503772/503776)

Micro Board-to-Board Connectors

SlimStack™	Family	(0.35)	0.40 a	nd 0.50m	m Pitch)
omnocacit		(0.00)	0110 0		

Pitch (mm)	Mated Height	Width (mm)	Receptacle	Plug	Circuit Sizes	Speed [†]	Current (max.)	Voltage (max.)	Key Features
0.35	0.60	2.00	504618	504622	10, 20, 24, 30, 34, 40, 50, 64		0.3A	50V	Low-profile alignment; click feeling
			505066 Armo	Type 505070	6, 12, 16, 30, 40, 48		0.3A (Signal) 3.0A (Power)	50V	Alignment; protective armor cover; power nails
	0.75 (0.80 max.)	2.50	505004 Hybrid	Power 505006	8	40 Gbps	0.3A (Signal) 6.0A (Power)	50V	Alignment; High Current; 6A/2 pin
	0.70	2.60	503304	503308	10, 12, 16, 18, 20, 24, 26, 30, 40, 42, 50, 80				Two-point contact; narrow width
			503548	503552	6, 10, 12, 14, 16				High-retention; narrow width
	0.80	2.50	503772	503776	10, 20, 24, 30, 34, 40, 50, 60				Robust; reliable; easy to operate
0.40	0.90	3.40	501591	501594	10, 12, 20, 22, 24, 26, 30, 34, 40, 44, 50, 54, 70	Contact Molex			Space-saving J-Lead SMT tail
	1.00	2.60	502426	502430	8, 14, 20, 22, 24, 26, 30, 32, 40, 44, 50, 60, 64, 80	40 Gbps	0.3A	50V	Narrow width; space- saving J-Lead
	1.00	2.60	503489	503308	30, 44, 50, 60	40 0005		201	Two-point contact; narrow width
	1.50	3.40	51338	55909	12, 16, 20, 22, 24, 26, 30, 34, 40, 50, 60, 70, 80, 90, 100	40 Gbps			Large circuit-size range; space-saving J-Lead SMT tail
	1.80	4.20	500913	55909	20, 30, 40, 50, 60, 70, 90, 100	Contact Molex			Receptacle also mates with 501745
0.50	1.50	6.00	54722	55560	16, 20, 22, 24, 30, 36, 40, 50, 60, 80	30 Gbps			Space-saving PCB pattern layout
	4.00	5.40	52991	501920	30, 40, 50		0.5A		Two mating receptacles

*Note 1: All dimensions in mm. 'Note 2: The speed is derived from the simulation result on GSSGSSG differential 100Ω signaling for only the connector portion (does not contain any PCB/FPC characteristics). The speed (Gbps) is obtained by simply doubling the usable frequency (GHz), which is defined as the frequency at which the insertion loss exceeds -3dB. Return loss and crosstalk are not taken into account when determining the speed values here. However, they should be considered when judging the connector's overall capabilities.

SlimStack[™] Family Innovations (0.635/0.80/1.00mm Pitch)

High-S	peed	Capa	bilities
---------------	------	------	----------

Height	Cross Talk @100ps			Impe	dance	Insertio	Skew	
mm	Frequency	Near End	Far End	RT	Ohms	Frequency	dB	Pico Second
	1	4.7	6.5	50	54.9	1	0.23	0
9	2	4.6	6.4	100	53.3	2	0.13	0
	3	4.5	6.6	500	53.7	3	1.72	0

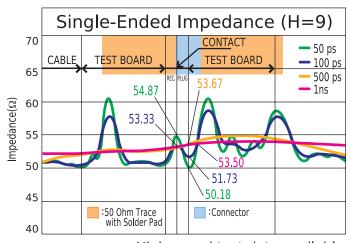
*Note: Above test results based on single-ended measurements, 1:1 signal/ground layout and 9.00mm (.354") stack height. (Contact Molex for latest test data)

0.635mm Pitch Family

• 3GHz performance • Cross Talk <7%

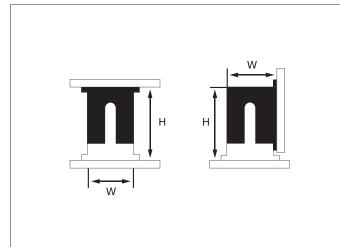
• For 50 and 100 Ohm

- Easy board processing
- Superior wipe length
- H-SPICE and 3d VRML models



High speed test data available

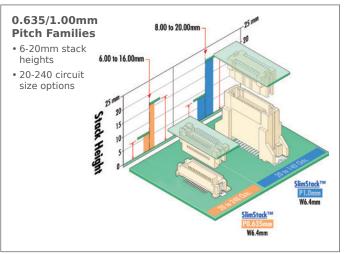
Vertical and Right-Angle Options



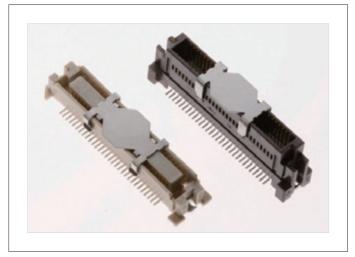
0.80mm Pitch Family

- 4.50mm height right-angle option
- Economical tin plating
- 10-40 circuit sizes

Wide Range of Stack Height and Circuit Sizes



Pick-and-Place Features



0.635 and 0.80mm Pitch Families

- Optional metal vacuum cap enables easy board placement (0.635mm type)
- Flat surface (0.80mm type)

> Micro Board-to-Board Connectors

SlimStack™	Family	(0.635/0.80	and	1 00mm	Pitch)
JIIIIJLAUK	ranniy	(0.055/0.00	anu	T.0011111	I ILCII)

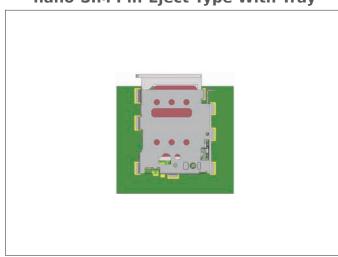
Pitch (mm)	Receptacle	Plug	Mated Height	Mated Width	Circuit Sizes	Speed [†]	Current (max.)	Voltage (max.)	Plating	Key Features
		55091	6.00		20, 30, 40, 50, 60,70, 80, 90, 100, 120, 140, 160					
		53625	7.00		30, 40, 50, 60,80, 90, 120, 140, 160, 240	· 20 Gbps				
	52885	53647	8.00	6.20	20, 30, 40, 60, 80, 100, 120, 140, 160	20 0005				
	52005	53649	9.00		30, 40, 60, 80, 100					
0.635		53627	10.00		20, 30, 40, 50, 60, 70, 80, 90, 100, 120, 140	- 10 Gbps	0.5A	100V	Gold	Pick-and-
0.035		55091	12.00		20, 30, 40, 50, 60, 70, 80, 90, 100, 120, 140, 160			1007	Gold	place cap
		53625	13.00	6.40	30, 40, 50, 60, 80, 90, 120, 140, 160, 240					
	52901	53647	14.00		20, 30, 40, 60, 80, 100, 120, 140, 160					
	-	53649	15.00		30, 40, 60, 80, 100					
		53627	16.00		20, 30, 40, 50, 60, 70, 80, 90, 100, 120, 140					
		53307	4.50		10, 12, 14, 18, 20, 24, 26, 28, 30, 36, 40					
0.80		53364	6.00	5.10	18, 20, 30, 36			50V	Tin	Vertical and right angle
0.80	52465	53353	7.00	5.10	10, 18, 20, 28, 30, 40	Contact		200		options
		53309	5.65		10, 12, 14, 16, 18, 20, 22, 24, 26, 28, 30, 32, 36, 40	, , ,				
1.00	52584	J.	18.00	6.60	50, 60, 80,			1001/		High stack
1.00	52602	53408	20.00	6.60	100, 120, 140			100V	Gold	heights and circuit sizes

*Note 1: All dimensions in mm. 'Note 2: The speed is derived from the simulation result on GSSGSSG differential 100Ω signaling for only the connector portion (does not contain any PCB/FPC characteristics). The speed (Gbps) is obtained by simply doubling the usable frequency (GHz), which is defined as the frequency at which the insertion loss exceeds -3dB. Return loss and crosstalk are not taken into account when determining the speed values here. However, they should be considered when judging the connector's overall capabilities.

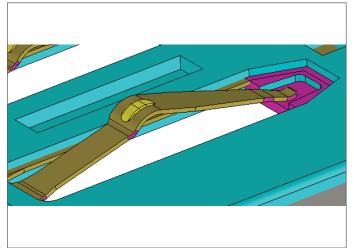
nano-SIM, Combo and micro-SD Memory Card Connector Innovations

nano-SIM Pin-Eject Type With Tray





• Includes 8 points of shell-to-PCB retention



Anti-Stubbing

Card insertion direction is the same as the terminals, which provides for smooth mating and prevents terminal buckling. (On many series)

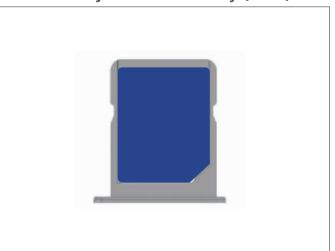
Anti-Shorting Feature



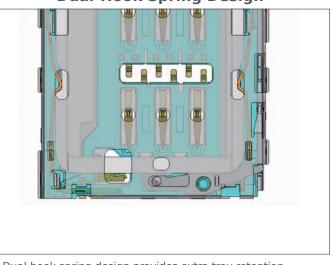
 A raised housing wall serves as an anti-short feature (78723 Push-Pull Series)



(104168 shown)



• Metal trays provide secure card retention and match aesthetic design of phone.



Dual-Hook Spring Design

• Dual-hook spring design provides extra tray retention (505020 shown)

Metal Injection Mold Tray (MIM)

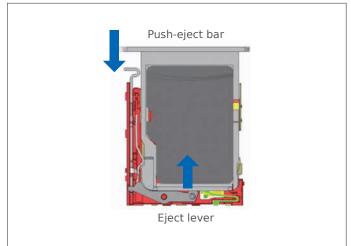
> Micro Memory Card Connectors

Card Type	Ejection Style	Order Number	Mounting Style	Height	Width	Depth	Depth With Card	Detect Switch	Circuit Size	Current (max.)	Voltage (max.)	Key Features
nano-SIM	Pin-Eject Type With Tray	504520-0691	_	1.30	13.4	15.1	17.70	Yes	6			Easy pin-eject method and custom tray
microSD/ microSIM	Push-Pull	104168-1620	Nerred	2.28	13.00	18.30	19.20	mSD : Yes, mSIM : No	8	0.50	10	Contact crash protection feature; through- hole nail
Combo	Pin-Eject Type With Tray, Single Hook	505020-0692	Normal	1.35	16.55	16.35	18.20	Yes	6	0.50	10	Low Profile; can customize tray
microSIM	Push-Pull	78723-1001		1.35	12.80	14.42	14.42	No	6			Push-Pull with polarisation features

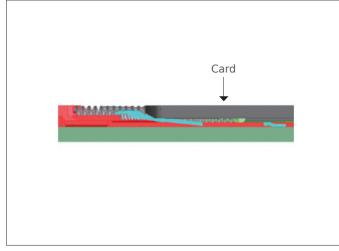
nano-SIM, microSD/micro-SIM Combo and micro-SIM Memory Card Connectors

microSD Memory Card Connector Innovations

Pin-Eject Type With Tray



Anti-Buckling



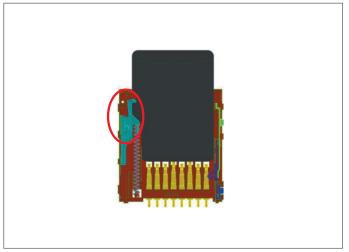
Card insertion direction is the same as the terminals, which provides for smooth mating and prevents terminal buckling. (On many series)

1.28 mm

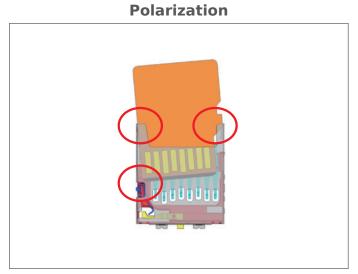
Low-Profiles

(503398 shown)

Smooth Card Ejection

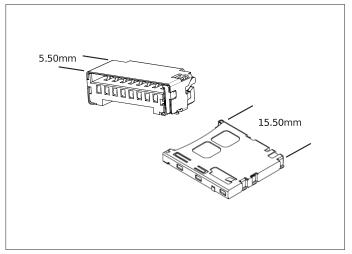


• Features in the housing, cam and shell design provide smooth and controlled card ejection (Various features on all series)



 Polarization features on both housing and shell prevent improper mating of the card before it touches the detect switch (Various features on all series)

Push-Pull Half-Size Type



 Half-size versions can save up to 65% space in PCB width as shown above

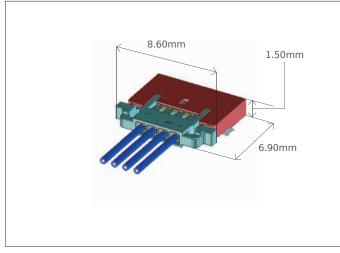
> Micro Memory Card Connectors

microSD Memory Card Connectors

Card Type	Ejection Style	Order Number	Mounting Style	Height	Width	Depth	Depth With Card	Detect Switch	Circuit Size	Current (max.)	Voltage (max.)	Key Features
	Push-Push	503398-1892		1.28	13.10	14.05	16.85					Back-side detect switch position
	Pin-Eject Type With Tray	Pages 1		1.40	15.60	16.35	17.75					Easy pin-eject method and custom tray
		504528-0892	Normal	1.45	14.90	14.95	17.35	_	8	0.50A		Anti-card fly-out
	Push-Push	503182-1852		1.80	13.80	15.50	17.20				10V	Anti-card fly-out; Anti-card sticking
		502774-0891	Reverse	1.80	14.30	16.00	18.10					Reverse type
microSD	Push-Pull	504077-1891		1.28	11.32	13.00	15.40	Yes				Ultra-Low Profile
	Push-Pull	104031-0811		1.42	11.95	11.40	15.40					With detect switch
	Hinge	500901-0801	Normal	1.93	14.60	14.50	15.00					Hinge type
	Puch-Pull	104032-0821		2.85	11.40	4.60	15.30				5V	With detect switch
	(Half size)			3.35	11.40	5.50	15.30	30				Push-pull with detect switch

0.40 to 1.25mm Pitch Innovations

Low-Profile With Side Locks





Wide Variation

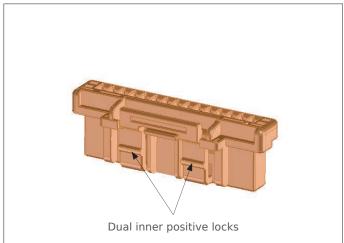


Pico-Clasp[™] 1.0

Low-Profile Horizontal Mating

Pico-EZmate[™] 1.20

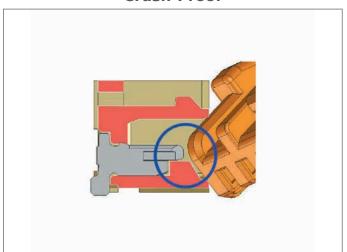
Reliable "Click" Feeling



CLIK-Mate[™] 1.25

• Dual inner positive locks provide audible "click", low insertion force and secure mating retention





CLIK-Mate[™] 1.25

 Crush-proof mating design protects contact pins and terminal from damage during mating

Reinforced Solder Tabs



Duo-Clasp[™] 1.25 Also with gold plating and protective dual inner locks

> Micro Wire-to-Board Connectors

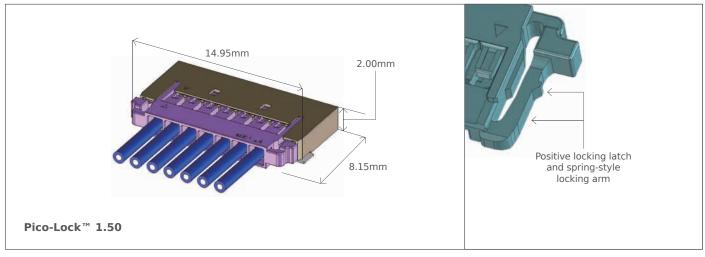
0.40 to 1.25mm Pitch

Pitch (mm)	Family Name	Terminal	Housing	Vertical PCB Header/ Receptacle	Right Angle PCB Header/ Receptacle	Plating	Lock Type	Circuit Sizes	Wire Gauge	Current (max.)	Voltage (max.)	Key Features
0.40	Micro IDT Coaxial	IDT He 501	busing 800	H=1.15, W=5.50 Top Entry, 501083	H=2.40, W=3.94 Side Entry, 501044	Gold	Friction	30, 40, 50	42 (AWG)	0.2A	30V	Low profile; superior shielding; flexible routing;
	Pico- Lock™ 1.00	503765	503764	N/A	H=1.50, W=6.90 503763	Gold	Positive/ Friction	2, 3, 4, 5, 6	28-30 (AWG)	1.5A	150V	Space- saving positive side locks; high current
1.00	Pico- Clasp™ Single Row Inner Lock		501330	H=6.20, W=3.50 (2- 5ckts) W=4.47 501331	H=3.20 (2-5ckts) W=4.70 501568	Tin	Positive (2-5ckts) Inner Positive (6-15ckts)	2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15				
1.00	Pico- Clasp™ Single Row Outer Lock	501334	501939	H=5.90, W=4.50 501940	H=4.80, W=5.80 501953		Outer Positive	3, 4, 5	28-32 (AWG)	1.0A		Small pitch; positive lock; wide variety
	Pico- Clasp™ Dual Row	501193	501189	H=6.20, W=6.67 501190	H=8.30, W=6.70 501571		Inner Positive	20, 30, 40, 50				
1.20	Pico- EZmate™	78172	78172	N/A	H=1.55 (2-5ckts) W=1.65 78171	Gold	Friction (Horizotal Mating)	2, 3, 4, 5, 6, 7	28-30 (AWG)	1.5A	50V	Horizontal mating and ultra- low-profile
	CLIK- Mate™	502381	502380	H=7.80, W=5.45 502382	H=5.55, W=7.65 502386	Tin	lanar	2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15	26.20			Audible "click" mating
1.25	Duo- Clasp™	501930	503110	H=10.95, W=9.00 501931	H=7.85, W=10.95 502046	Gold	Inner Positive	20, 30, 40	26-28 (AWG)	1.0A		Gold plating; dual inner positive locks; reinforced solder tabs
	Pico- Blade™	50058/50079	51021	H=5.20, W=3.20 H=5.20, W=3.20 S3047 (T/H)	H=3.50, W=6.50 53048 (T/H)	Tin	Friction	2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15	26-30 (AWG)		125V	Ultra- small size; SMT and through- hole options

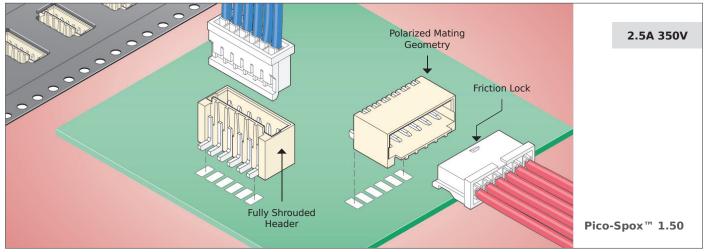
Micro Wire-to-Board Connectors

1.50mm Pitch Innovations

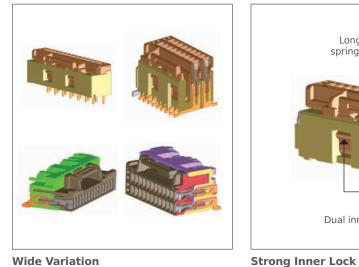
Low-Profile With Side Locks



High Voltage Friction-Lock Design

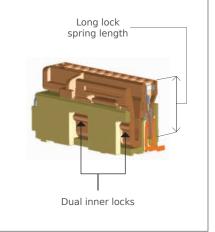


CLIK-Mate[™] 1.50: Various Design Options and Mating Protection



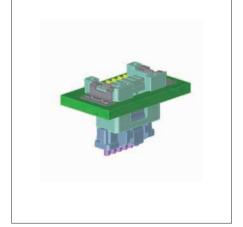
Wide Variation

- Single/Dual Rows
- Straight and Right-Angle
- SMT and Through-Hole



Inner lock provides space spacings,

latch protection and strong "click" feel



- **Bottom-Entry Option**
- Provides space saving and easier assembly for bottom-entry applications such as LED lighting

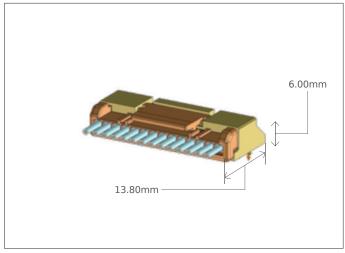
> Micro Wire-to-Board Connectors

1.50mm Pitch

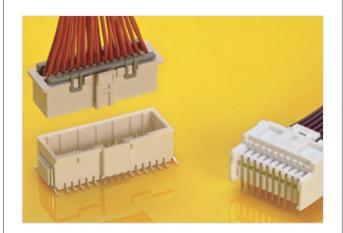
Pitch (mm)	Family Name	Terminal	Housing	Vertical PCB Header/ Receptacle	Right Angle PCB Header/ Receptacle	Plating	Lock Type	Circuit Sizes	Wire Gauge	Current (max.)	Voltage (max.)	Key Features
	Pico-Lock™	504052	504051	N/A	H=2.00, W=8.15 504050	Gold	Side Positive	4, 6, 7, 8, 10,12	24-28 (AWG)	3.0A (4- 7ckts), 2.0A (8- 12ckts)	150V	Low profile and high current
	Pico-SPOX™	87421	87439	H=7.40, W=4.45 87437	H=4.45, W=7.40 87438		Friction			2.5A	350V	High current and reliable two-point contact
1.50	CLIK-Mate™ Single Row	502579/ 503429	502578	H=9.70, W=6.35 502584 (SMT) H=10.35, W=6.55 503159 (T/H)	H=6.40, W=9.65 502585 (SMT) H=6.95, W=9.65 503175 (T/H)	Tin		2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15	24-30 (AWG)			Low insertion force; secure mating with audible "click"; latch/contact protection
	CLIK-Mate™ Single Row Bottom Entry	502579/ 503429	502578	H=11.30, W=9.50 503395	N/A	5	Inner Positive	3, 4, 6, 7, 8, 10	,	2.0A	100V	For through- broard mating applications
	CLIK-Mate™ Dual Row	502579/ 503429	503149	H=11.20, W=9.20 503154	H=9.20, W=11.20 503148			Vertical 8, 10, 12, 16, 20, 22, 24, 28, 30, 32, 34 Right Angle 10, 12, 16, 20, 24				Low insertion force; secure mating with audible "click"; latch/contact protection

2.00mm Pitch Innovations

Space Savings



• All families (Micro-Lock[™] shown)



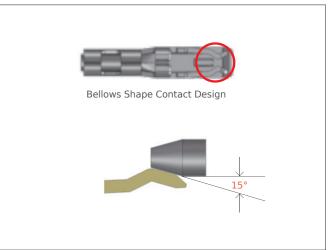
• Micro-Clasp[™] (Single/Dual/Vertical/RA/SMT/Through Hole)

Robust Designs



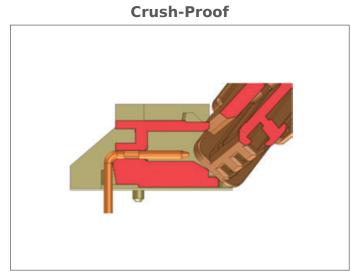
• All families (iGrid[™] shown)

Low-Insertion Force



Micro-Lock™

• Below-shaped terminal design provides reduced mating angle for lower insertion force – even with tin plating



 $\mathsf{Micro-Lock}^{\,\mbox{\tiny M}}$ and $\mathsf{CLIK}\mbox{-Mate}^{\,\mbox{\tiny M}}$

• Crush-proof mating design protects contact pins and terminal from damage during mating

Reinforced Solder Tabs



CLIK-Mate™

 Robust solder tabs provide secure PCB retention and solder joint protection

Wide Variation

> Micro Wire-to-Board Connectors

2.00mm Pitch

Pitch (mm)	Family Name	Terminal	Housing	Vertical PCB Header/ Receptacle	Right Angle PCB Header/ Receptacle	Plating	Lock Type	Circuit Sizes	Wire Gauge	Current (max.)	Voltage (max.)	Key Features
	CLIK- Mate™	503438	502439	H=10.90, W=6.85 502443	H=6.90, W=10.85 502494			Vertical 4, 5, 6, 7, 8, 9, 10, 12, 13, 14, 15 (Right Angle) 4, 6, 8, 12, 13, 14, 15	22-26 (AWG)	3.0A		Audible "Click" mating
	iGrid™	501647/ 501648	501646	H=13.40, W=8.30 501645	H=8.40, W=15.90 501876		Inner Positive	10, 12, 14, 16, 18, 20, 22, 24, 26, 28, 30, 32, 34, 36, 38, 40		2.0A	250V	Robust design withstands vibration
	Micro- Clasp™ Single	La la	51382	H=13.20, W=7.15 55932	H=7.15, W=15.20 55935		FUSILIVE	2, 3, 4, 5, 6, 7, 8,9, 10, 11, 12, 13, 14, 15	22-28 (AWG)	3.0A		Single and dual; high current; robust
	Micro- Clasp™ Dual	56134	51353	H=13.20, W=11.50 55917	H=11.70, W=17.95 55959	-		8, 10, 12, 14, 16, 18, 20, 22, 24, 26, 28, 30, 32, 34, 36, 38, 40	-	3.UA		design withstands vibration
2.00	Micro- Blade™	50011	51004	H=7.80, W=4.40 53014	H=4.70, W=9.30 53015			2, 3, 4, 5, 6, 7, 8, 9,	24-30			Compact size; blade terminals provide good wiping
	Micro- Latch™	(The	a a a a a a a a a a a a a a a a a a a	H=7.30, W=4.00	H=4.55, W=9.10	. Tin	Friction	10, 11, 12, 13, 14, 15	(AWG)	2.0A	125V	Uses standard terminal; economical design
	Micro- Lock™	50212	51065	53253 N/A	53254		Outer Positive	4, 5, 6, 8, 10, 12, 14, 15	22-26 (AWG)	3.0A		"Crash- proof" pin protection feature; wide variation
	Micro- TPA™	59370	51216 (Housing) 51217 (Retainer)	H=13.45, W=6.25 55755	N/A		Inner Positive	2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15	22-28 (AWG)	2.5A	250V	Terminal retainer and high-wall headers
2.00/ 2.50	Board- In	35021	35023 (2.00 pitch) 35022 (2.50 pitch)	N/A	N/A		Positive	2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15	22-30 (AWG)	2.34	125V	Low profile and easy harness assembly

Specialty Connector Innovations





• Exceeds SAE Automotive Vibration test



DuraClik[™] ISL with retainer

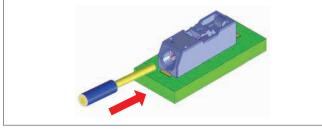


DuraClik[™] TPA with retainer

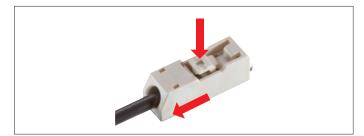
System Comparison

	eystein et		
Feature	DuraClik™	DuraClik™ ISL	DuraClik™ TPA
Small Size	\checkmark		
Audible Click	~	\checkmark	\checkmark
High temperature	105°C	125°C	125°C
Rentention Force	9.8N	50N	20N
Has a retainer		\checkmark	\checkmark
Box-shaped terminal	~	\checkmark	\checkmark
Lance design	Terminal lance	Terminal lance	Housing lance
Circuit sizes	2-15	2-8	2-15
Plating	Tin/Gold	Tin/Gold	Tin/Gold
Colors	Natural/Black	Natural	Black

Lite-Trap[™] Push-Button Connectors

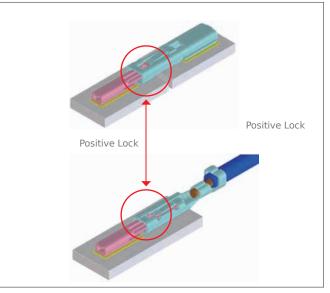


• Easy wire insertion and secure wire retention



• Push-button release enables easy wire removal

TermiMate[™] One-Piece WTB and BTB Connector System



• Space-saving, cost effective and flexible one-piece WTB and BTB design

> Micro Wire-to-Board Connectors

Specialty Connector	Innovations
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Pitch (mm)	Family Name	Terminal	Housing	Vertical PCB Header	Right Angle PCB Header	Plating	Lock Type	Circuit Sizes	Wire Gauge	Current (max.)	Voltage (max.)	Key Features
	DuraClik™	560085/ 50212/56161	502351	H=9.30, W=9.15 560020	H=6.40, W=10.70 502352	560085/ 50212 (Tin) 56161 (Gold)		2, 3, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15	22-30 (AWG)			9.8N Terminal Retention Force -40 to +105°C Operating Temperature
2.00	DuraClik™ ISL	N Starster Star	560123 (Housing) 560125	H=11.10, W=9.15	H=6.40, W=12.70		Inner Posi- tive	2, 3, 5, 6, 7, 8, 10	22 (AWG)	3.0A	125V	50N Terminal Retention Force -40 to +125°C Operating Temperature
		560124	(Retainer)	560020	502352	Tin/Gold						
	DuraClik™ TPA	505151 (Housing)	REPORT OF				2, 3, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15	22-24 (AWG)			20N Terminal Retention Force -40 to +125°C Operating Temperature	
		505153	505152 (Retainer)	H=11.10, W=9.15 560020	H=6.40, W=12.50 502352							

> Wire Trap-Style Solid/Stranded Wire System (For LED Lighting and Other Applications)

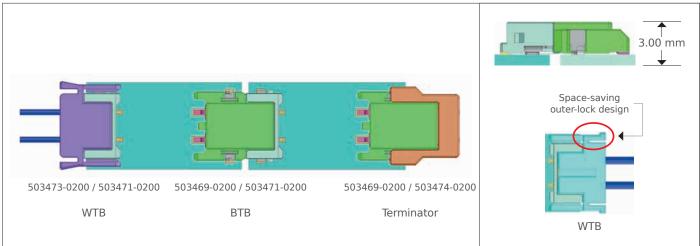
Pitch (mm)	Family Name	Right Angle Connector	Plating	Lock Type	Circuit Sizes	Wire Gauge	Current (max.)	Voltage (max.)	Key Features
3.00	Mini Lite-Trap™	H=2.65, W=7.90 104238	Tin	Wire-Trap	1, 2	22-26 (AWG)	3.0A	160V	High wire retention force
4.00	Lite-Trap™	H=4.20, W=13.00 104188	Tin	Wire-Trap	1, 2	18-24 (AWG)	9.0A	300V	with push- button release

> Terminal Type Wire-to-Board and Board-to-Board System (For LED Lighting and Other Applications)

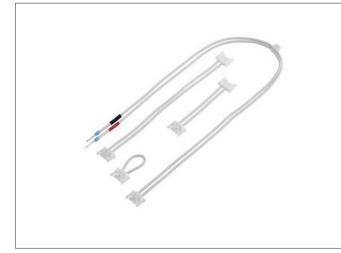
Pitch (mm)	Family Name	Terminal (Receptacle)	PCB Plug	PCB Receptacle	Plating	Lock Type	Circuit Sizes	Wire Gauge	Current (max.)	Voltage (max.)	Key Features
N/A	TermiMate™	505073		H=1.20, W=2.00 505072	Tin	Positive	1	22-26 (AWG)	3.0A	125V	WTB and BTB options; space savings

Specialty Connector Innovations





24 AWG Cable Assemblies



• Flexi-Mate standard cable lengths (46 to 600mm) for boardto-board, driver-to-board and wire loop W-to-B/W-to-W Capabilities

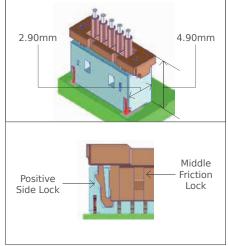




• Molex's MicroTPA[™] system offers wire-to-wire and wire-to-board intermateability

Specification	IllumiMate 1.00	IllumiMate 1.25			
Sub-families	3	5			
Circuit sizes (Vertical)	4, 5, 10	3, 5, 6, 10 4, 5, 6, 10, 15, 20, 25 1.0A, 1.5A			
Circuit sizes (Right Angle)	6, 14				
Current options	1.0A, 1.5A				
Voltage options	50V, 60V, 100V,150V	130V, 200V, 300V			
Wire Gauge (AWG)	30, 32	26-32			

IllumiMate[™] Narrow-Width W-to-B System



• Wide range of pitch sizes, mating configurations, wire gauge, current and voltage options

> Micro Wire-to-Board Connectors

Pitch (mm)	Family Name	Terminal	Housing	Vertical PCB Header	Right Angle PCB Header	Plating	Lock Type	Circuit Sizes	Wire Gauge	Current (max.)	Voltage (max.)	Key Features
1.00	IllumiMate™	104539	104128	H=2.45, W=7.30 104127	N/A	Tin	Inner Positive	4, 15, 10, 14	30-32 (AWG)	1.0, 1.5A	50, 60, 150V	High temperature material and wide variety of low-power voltage options
1.25	PanelMate™	50753/50641	51146	N/A	H=1.90, W=7.30 53780	Gold	Friction	2-20 4	28-32 (AWG)	1.0A	125V	Ultra-low profile
1.25	IllumiMate™	104505	104085	N/A	H=4.90, W=2.90 104086	Tin	Inner Positive	3, 4, 5, 6, 10, 15, 20, 25	26-32 (AWG)	1.0, 1.5A	125, 300V	High temperature material and wide variety of low-power voltage options

Specialty Connector Innovations

> Right Angle Wire-to-Board and Board-to-Board Connectors

Pitch (mm)	Family Name	Terminal	Housing	PCB Receptacle	PCB Plug	Terminator Receptacle	Plat- ing	Lock Type	Circuit Sizes	Wire Gauge	Current (max.)	Voltage (max.)	Key Features
3.70	Flexi-Mate™	503485	503473	H=3.00, W=8.40 503471	H=3.00, W=12.00 503469	H=3.00, W=13.70 503474	Tin	Friction (BTB); Positive (WTB)	2	26-28 (AWG)	2.0A	500V	WTB and BTB options in a low- profile design

Wire-to-Wire Connectors

Pitch (mm)	Family Name	Plug Terminal	Plug Housing	Receptacle Terminal	Receptacle Housing	Circuit Sizes	Wire Gauge	Current (max.)	Voltage (max.)	Key Features
1.25	PicoBlade™	50125 50133	51047	50079 (AWG 26-28)	51021	2 to 10	26-28 (AWG) 28-32 (AWG)	1.0A	125V	Thin design with friction lock
		50133	51047	50058 (AVVG 28-32)	51021					
2.00	MicroTPA™		51227			2 to 15	22-28 (AWG)	3.0A	250V	WTB and WTW options; terminal retainer and high-wall header for "potting"
		56086	51217 (Retainer)	59370	51216					

Get customized insights at: www.molex.com/link/microconnectors.html

